



TTL Compatible CMOS Analog Switches

General Description

Maxim's DG300-DG303 and DG300A-DG303A CMOS dual and quad analog switches combine low power operation with fast switching times and superior DC and AC switch characteristics. On-resistance is less than 50Ω and is essentially constant over the analog signal range. Device specifications are ideal for battery-powered circuitry.

These switches are available in a variety of formats as outlined in the *Pin Configurations* section. The switch control logic inputs are fully TTL and CMOS compatible. Also featured are "break-before-make" switching and low charge injection.

Maxim's DG300-DG303 and DG300A-DG303A families are electrically compatible and pin compatible with the original manufacturer's devices. All devices operate with power supplies ranging from $\pm 5V$ to $\pm 18V$. Single-supply operation is implemented by connecting V^- to GND.

Applications

Portable Instruments
Low-Power Sample/Holds
Power-Supply Switching
Programmable Gain Amplifiers
SPDT and DPDT Functions
Process Control and Telemetry

Features

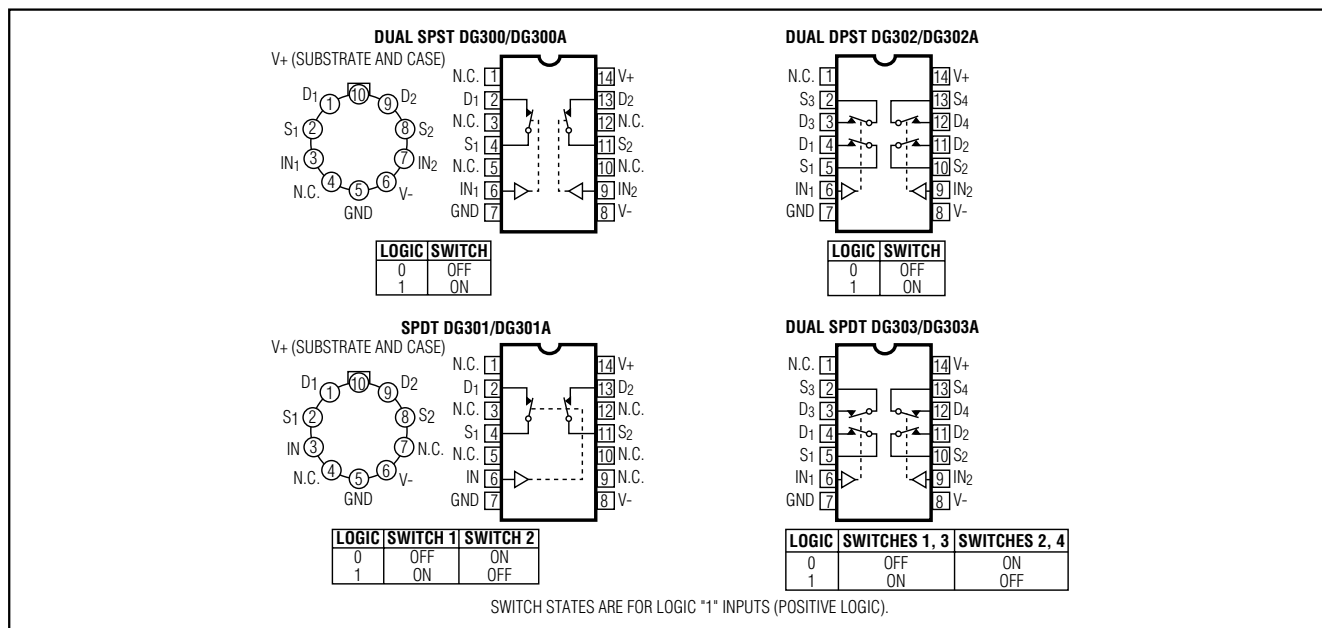
- ◆ Monolithic Low-Power CMOS
- ◆ Latchup Proof Construction
- ◆ Fully Compatible 2nd Source
- ◆ Low On-Resistance, $<50\Omega$
- ◆ Fast Switching Time
- ◆ V^+ to V^- Analog Signal Range
- ◆ Single-Supply Capability

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
DG300C/D	0°C to $+70^\circ\text{C}$	Dice
DG300CJ	0°C to $+70^\circ\text{C}$	14 Lead Plastic DIP
DG300CWE	0°C to $+70^\circ\text{C}$	16 Lead Wide SO
DG300CK	0°C to $+70^\circ\text{C}$	14 Lead CERDIP
DG300BWE	-25°C to $+85^\circ\text{C}$	16 Lead Wide SO
DG300BK	-25°C to $+85^\circ\text{C}$	14 Lead CERDIP
DG300BA	-25°C to $+85^\circ\text{C}$	10 Lead Metal Can
DG300AK	-55°C to $+125^\circ\text{C}$	14 Lead CERDIP
DG300AA	-55°C to $+125^\circ\text{C}$	10 Lead Metal Can

Ordering Information continued at end of data sheet.

Pin Configurations



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ABSOLUTE MAXIMUM RATINGS

Voltages Referenced to V-
V+ (DG300–DG303)36V
V+ (DG300A–DG303A)44V
GND25V
Digital Inputs, V_S, V_D, (Note 1)-4V to (V+ + 4V) or
30mA, whichever occurs first
Current, Any Terminal Except S or D30mA
Continuous Current, S or D30mA
(pulsed at 1ms, 10% duty cycle max)100mA
Storage Temperature (A & B suffix)-65°C to +150°C
(C suffix)-65°C to +125°C

Operating Temperature (A suffix)-55°C to +125°C
(B suffix)-25°C to +85°C
(C suffix)0°C to +70°C
Lead Temperature (soldering 10s)+300°C
Power Dissipation*
Cerdip (K) (derate 11mW/°C above +75°C)825mW
Plastic DIP (J) (derate 6.5mW/°C above +25°C)470mW
Metal Can (A) (derate 6mW/°C above +75°C)450mW

*Device mounted with all leads soldered or welded to PC board.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V+ = +15V, V- = -15V, GND = 0V, T_A = +25°C, unless otherwise noted.)

	PARAMETER	SYMBOL	TEST CONDITIONS	DG300–DG303A DG300A–DG303AA			DG300–DG303B/C DG300A–DG303AB/C			UNITS
				MIN	TYP	MAX	MIN	TYP	MAX	
				(Note 2)	(Note 3)		(Note 2)	(Note 3)		
SWITCH	Analog Signal Range	V _{ANALOG}	I _S = 10mA, V _{IN} = 0.8V or 4.0V	-15		+15	-15		+15	V
	Drain-Source ON-Resistance	R _{DS(ON)}	V _{IN} = 0.8V or V _{IN} = 0.8V	I _S = -10mA, V _D = 10V		30	50	30	50	Ω
				I _S = -10mA, V _D = -10V		30	50	30	50	
	Source OFF-Leakage Current	I _{S(OFF)}		V _S = 14V, V _D = -14V		0.1	1	0.1	5	nA
	Drain OFF-Leakage Current	I _{D(OFF)}		V _S = -14V, V _D = 14V		-1	-0.1	-5	-0.1	nA
	Drain ON-Leakage Current	I _{D(ON)}		V _S = 14V, V _D = -14V		-1	-0.1	-5	-0.1	nA
INPUT	Input Current/ Voltage High	I _{INH}	V _{IN} = 5.0V	-1	-0.001		-1	-0.001		μA
	Input Current/ Voltage Low	I _{INL}	V _{IN} = 15V		0.001	1		0.001	1	μA
DYNAMIC	Turn-ON Time	t _{ON}	See Switching Time Test Circuit		150	300		150	300	ns
	Turn-OFF Time	t _{OFF}			130	250		130	250	ns
	Break-Before-Make Interval	t _{ON} - t _{OFF}	See Break-Before-Make Time Test Circuit, DG301(A)/DG303(A) only		50			50		ns
	Charge Injection	Q	C _L = 10nF, R _{GEN} = 0Ω, V _{GEN} = 0V		12			12		pC
	Source OFF-Capacitance	C _{S(OFF)}	f = 1MHz, V _{IN} = 0.8V or V _{IN} = 4.0V		14			14		pF
	Drain OFF-Capacitance	C _{D(OFF)}			14			14		pF
	Channel ON-Capacitance	C _{D(ON)} + C _{S(ON)}			40			40		pF
	Input Capacitance	C _{IN}	f = 1MHz		6			6		pF
	Off-Isolation (Note 4)		V _{IN} = 0V, R _L = 1kΩ		62			62		dB
	Crosstalk (Channel-to-Channel)		V _S = 1V _{RMS} , f = 500kHz		74			74		dB

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ELECTRICAL CHARACTERISTICS (continued)

(V₊ = +15V, V₋ = -15V, GND = 0V, T_A = +25°C, unless otherwise noted.)

	PARAMETER	SYMBOL	TEST CONDITIONS	DG300–DG303A DG300A–DG303AA			DG300–DG303B/C DG300A–DG303AB/C			UNITS
				MIN	TYP	MAX	MIN	TYP	MAX	
				(Note 2)	(Note 3)		(Note 2)	(Note 3)		
SUPPLY	Positive Supply Current	I ₊	V _{IN} = 4V (one input) (all others = 0)		0.23	0.5		0.23	0.5	mA
	Negative Supply Current	I ₋		-10	-0.001		-10	-0.001		μA
	Positive Supply Current	I ₊	V _{IN} = 0.8V (all inputs)		0.001	10		0.001	10	μA
	Negative Supply Current	I ₋		-10	-0.001		-10	-0.001		μA

ELECTRICAL CHARACTERISTICS (Over Temperature)

(V₊ = +15V, V₋ = -15V, GND = 0V, T_A = Over Temperature Range, unless otherwise noted.)

	PARAMETER	SYMBOL	TEST CONDITIONS		DG300–DG303A DG300A–DG303AA			DG300–DG303B/C DG300A–DG303AB/C			UNITS
					MIN	TYP	MAX	MIN	TYP	MAX	
					(Note 2)	(Note 3)		(Note 2)	(Note 3)		
SWITCH	Analog Signal Range	V _{ANALOG}	I _S = -10mA, V _{IN} = 0.8V or 4.0V		-15		+15	-15		+15	V
	Drain-Source ON-Resistance	R _{DS(ON)}	V _{IN} = 0.8V or V _{IN} = 0.8V	I _S = -10mA, V _D = 10V			75			75	Ω
		I _S = -10mA, V _D = -10V				75			75		
	Source OFF-Leakage Current	I _{S(OFF)}		V _S = 14V, V _D = -14V			100			100	nA
		V _S = -14V, V _D = 14V		-100			-100			-100	
	Drain OFF-Leakage Current	I _{D(OFF)}		V _S = -14V, V _D = 14V			100			100	nA
		V _S = 14V, V _D = -14V		-100			-100			-100	
Drain ON-Leakage Current	I _{D(ON)}	V _D = V _S = 14V			200			200	nA		
	V _D = V _S = -14V	-200			-200			-200			
INPUT	Input Current/ Voltage High	I _{INH}	V _{IN} = 5.0V		-1			-10			μA
			V _{IN} = 15V				1			10	
	Input Current/ Voltage Low	I _{INL}	V _{IN} = 0V		-1			-10			μA
SUPPLY	Positive Supply Current	I ₊	V _{IN} = 4V (one input) (all others = 0)				1			1	mA
	Negative Supply Current	I ₋			-100			-200			-200
	Positive Supply Current	I ₊	V _{IN} = 0.8V (all inputs)				100			200	μA
	Negative Supply Current	I ₋			-100			-200			-200
DYNAMIC	Turn-ON Time	t _{ON}	See Switching Time Test Circuit				500				ns
	Turn-OFF Time	t _{OFF}					450				

DG300(A)/DG301(A)/DG302(A)/DG303(A)

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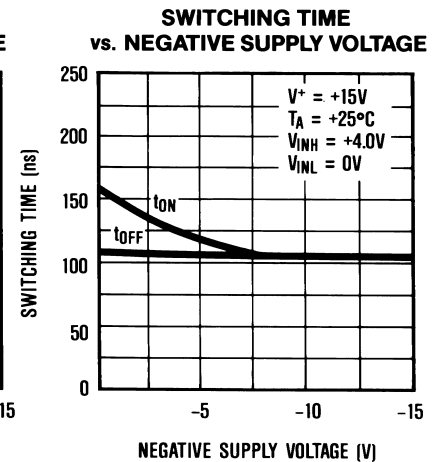
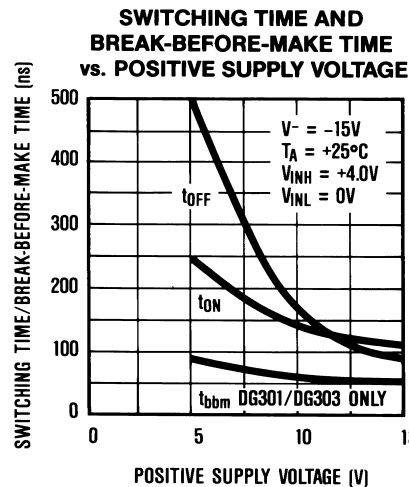
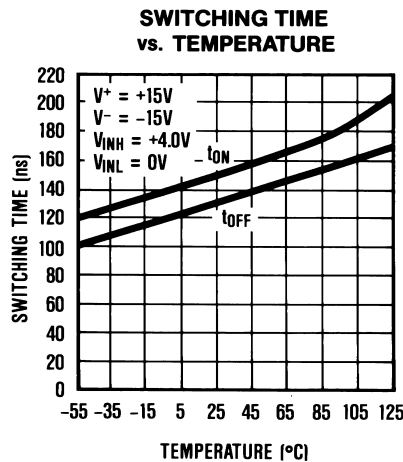
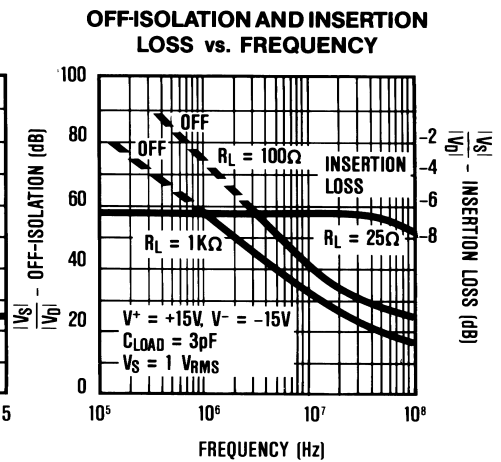
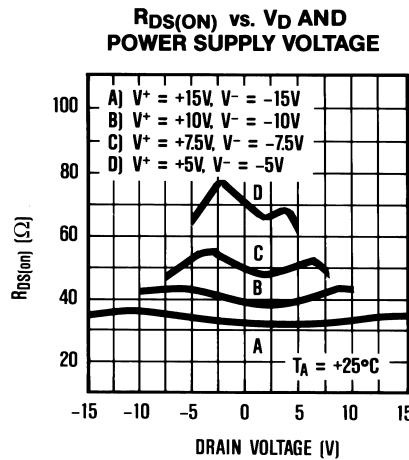
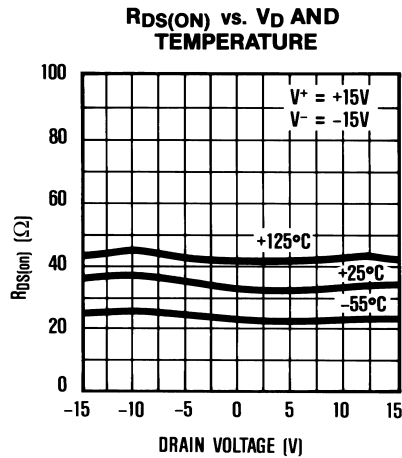
ELECTRICAL CHARACTERISTICS (Over Temperature) (continued)

($V_+ = +15V$, $V_- = -15V$, GND = 0V, $T_A =$ Over Temperature Range, unless otherwise noted.)

- Note 1:** Signals on S_X , D_X , or IN_X exceeding V_+ or V_- are clamped by internal diodes. Limit diode forward current to maximum current ratings.
- Note 2:** The algebraic convention whereby the most negative value is a minimum, and the most positive value is a maximum is used in this data sheet.
- Note 3:** Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
- Note 4:** OFF-isolation = $20 \log \frac{V_S}{V_D}$, V_S = input to OFF switch, V_D = output.

Typical Operating Characteristics

($T_A = +25^\circ C$, unless otherwise noted.)



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Test Circuits

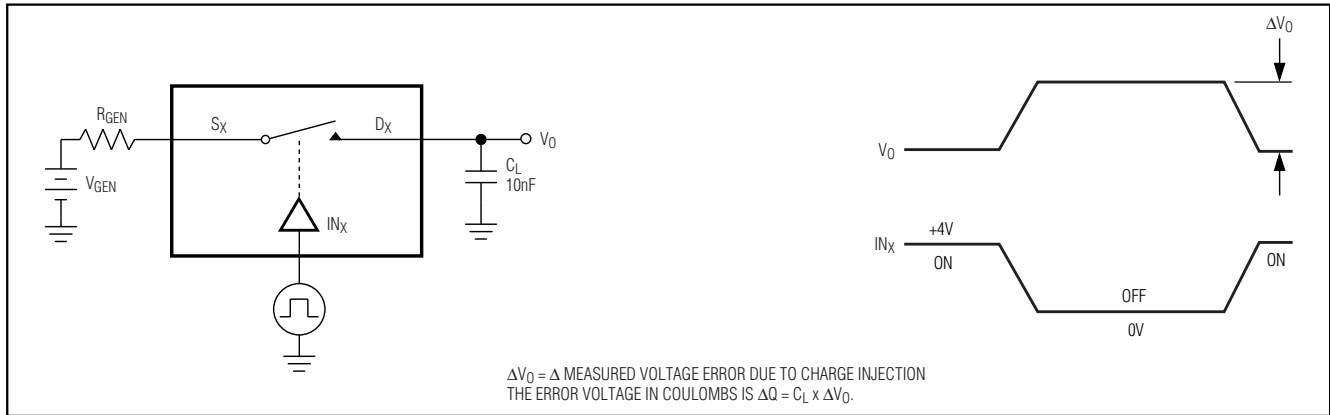


Figure 1. Charge Injection Test Circuit

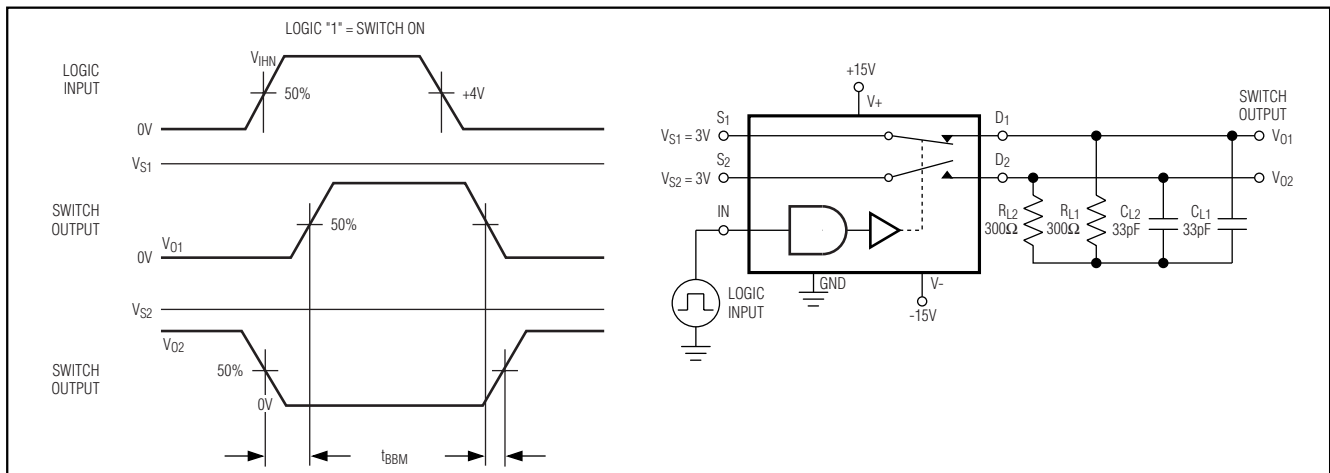


Figure 2. Break-Before-Make Time Test Circuit SPDT (DG301(A), DG303(A))

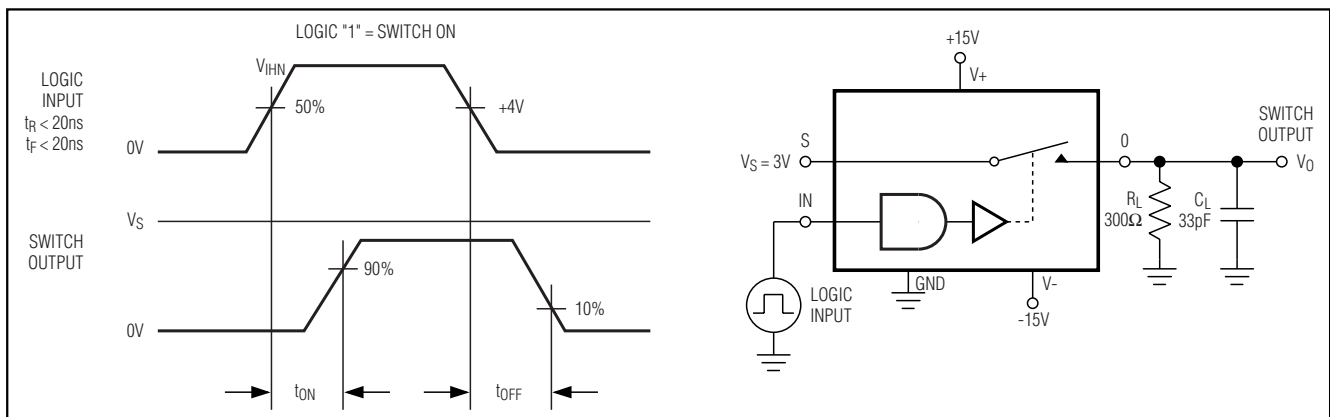


Figure 3. Switching Time Test Circuit

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Table 1. Typical Single Supply Parameters

PARAMETER		V+ SUPPLY VOLTAGE (V- = 0V)			
		+10V	+15V	+20V	+30V
Switching Time (RL = 1kΩ)	tON	190ns	150ns	110ns	70ns
	tOFF	40ns	40ns	40ns	40ns
On-Resistance	V SIGNAL = +1V	71Ω	51Ω	42Ω	31Ω
	V SIGNAL = V+ / 2	77Ω	54Ω	43Ω	30Ω
	V SIGNAL = V+	84Ω	63Ω	54Ω	43Ω
Input Logic Levels		0.8V, 4.0V	0.8V, 4.0V	0.8V, 4.0V	0.8V, 4.5V

Applications Information

All DG300 family switches will operate with ±5V to ±15V power supplies. They can also be used with single-ended power supplies ranging from +10V to +30V where the V-terminal is connected to ground. In either case, analog signals ranging from V+ to V- can be switched.

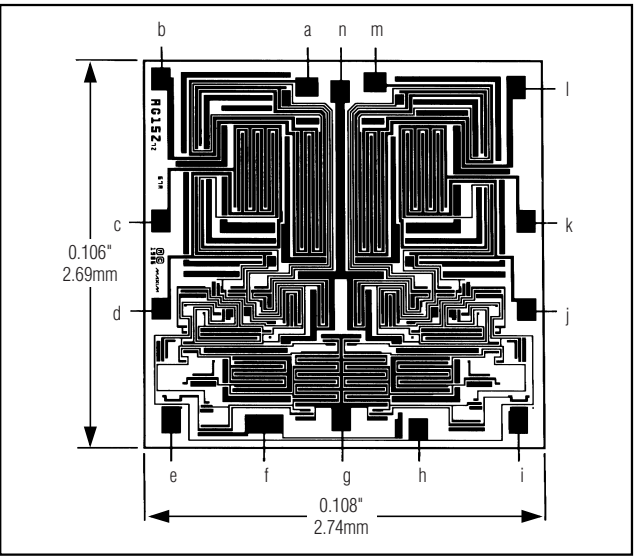
The on-resistance variation with analog signal and supply voltage is shown in the *Typical Operating Characteristics*. The temperature coefficient of RON is typically 0.5%/°C. Typical on-resistance matching from channel to channel is 10%. In addition, Table 1 outlines some typical parameters for single-supply operation.

Table 2. Charge Injection (±15V Supplies)

ANALOG INPUT (V)	INJECTED Q (pC)
+10	4
+5	8
0	12
-5	8
-10	5

The charge injection test circuit is shown in Figure 1. Table 2 lists the typical injected charge for DG300 series switches with various input voltages.

Chip Topography



DIE PAD	DG300 DG300A	DG301 DG301A	DG302/DG303 DG302A/DG303A
a	N.C.	N.C.	S3
b	D1	D1	D3
c	D1	S1	D1
d	S1	IN1	S1
e	IN1	IN1	IN1
f	V+	V+	V+
g	GND	GND	GND
h	V-	V-	V-
i	IN2	GND	IN2
j	S2	V-	S2
k	D2	S2	D2
l	D2	D2	D4
m	N.C.	N.C.	S4
n	V+	V+	V+

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Ordering Information (continued)

PART	TEMP RANGE	PIN-PACKAGE
DG300AC/D	0°C to +70°C	Dice
DG300ACJ	0°C to +70°C	14 Lead Plastic DIP
DG300ACWE	0°C to +70°C	16 Lead Wide SO
DG300ACK	0°C to +70°C	14 Lead Cerdip
DG300ABWE	-25°C to +85°C	16 Lead Wide SO
DG300ABK	-25°C to +85°C	14 Lead Cerdip
DG300ABA	-25°C to +85°C	10 Lead Metal Can
DG301C/D	0°C to +70°C	Dice
DG301CJ	0°C to +70°C	14 Lead Plastic DIP
DG301CWE	0°C to +70°C	16 Lead Wide SO
DG301CK	0°C to +70°C	14 Lead Cerdip
DG301BWE	-25°C to +85°C	16 Lead Wide SO
DG301BK	-25°C to +85°C	14 Lead Cerdip
DG301BA	-25°C to +85°C	10 Lead Metal Can
DG301AK	-55°C to +125°C	14 Lead Cerdip
DG301AA	-55°C to +125°C	10 Lead Metal Can
DG301AC/D	0°C to +70°C	Dice
DG301ACJ	0°C to +70°C	14 Lead Plastic DIP
DG301ACWE	0°C to +70°C	16 Lead Wide SO
DG301ACK	0°C to +70°C	14 Lead Cerdip
DG301ABWE	-25°C to +85°C	16 Lead Wide SO
DG301ABK	-25°C to +85°C	14 Lead Cerdip
DG301ABA	-25°C to +85°C	10 Lead Metal Can
DG302C/D	0°C to +70°C	Dice
DG302CJ	0°C to +70°C	14 Lead Plastic DIP

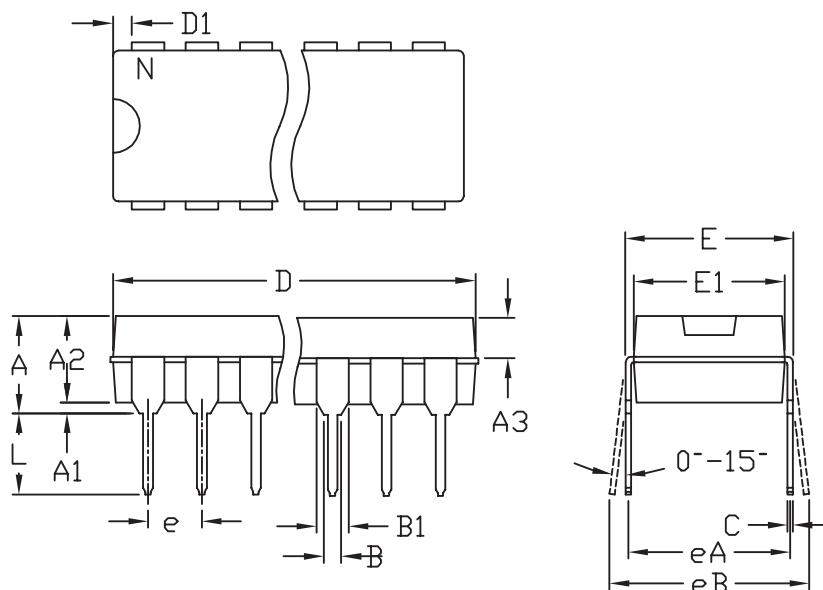
PART	TEMP RANGE	PIN-PACKAGE
DG302CWE	0°C to +70°C	16 Lead Wide SO
DG302CK	0°C to +70°C	14 Lead Cerdip
DG302BWE	-25°C to +85°C	16 Lead Wide SO
DG302BK	-25°C to +85°C	14 Lead Cerdip
DG302AK	-55°C to +125°C	14 Lead Cerdip
DG302AC/D	0°C to +70°C	Dice
DG302ACJ	0°C to +70°C	14 Lead Plastic DIP
DG302ACWE	0°C to +70°C	16 Lead Wide SO
DG302ACK	0°C to +70°C	14 Lead Cerdip
DG302ABWE	-25°C to +85°C	16 Lead Wide SO
DG302ABK	-25°C to +85°C	14 Lead Cerdip
DG303C/D	0°C to +70°C	Dice
DG303CJ	0°C to +70°C	14 Lead Plastic DIP
DG303CWE	0°C to +70°C	16 Lead Wide SO
DG303CK	0°C to +70°C	14 Lead Cerdip
DG303BWE	-25°C to +85°C	16 Lead Wide SO
DG303BK	-25°C to +85°C	14 Lead Cerdip
DG303AK	-55°C to +125°C	14 Lead Cerdip
DG303AC/D	0°C to +70°C	Dice
DG303ACJ	0°C to +70°C	14 Lead Plastic DIP
DG303ACWE	0°C to +70°C	16 Lead Wide SO
DG303ACK	0°C to +70°C	14 Lead Cerdip
DG303ABWE	-25°C to +85°C	16 Lead Wide SO
DG303ABK	-25°C to +85°C	14 Lead Cerdip

DG300(A)/DG301(A)/DG302(A)/DG303(A)

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Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



PDIPN:EPS

	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	---	0.180	---	4.572
A1	0.015	---	0.38	---
A2	0.125	0.175	3.18	4.45
A3	0.055	0.080	1.40	2.03
B	0.015	0.022	0.381	0.56
B1	0.045	0.065	1.14	1.65
C	0.008	0.014	0.2	0.355
D1	0.005	0.080	0.13	2.03
E	0.300	0.325	7.62	8.26
E1	0.240	0.310	6.10	7.87
e	0.100	BSC.	2.54	BSC.
eA	0.300	BSC.	7.62	BSC.
eB	0.400	BSC.	10.16	BSC.
L	0.115	0.150	2.921	3.81

	INCHES		MILLIMETERS			
	MIN	MAX	MIN	MAX	N	MS001
D	0.348	0.390	8.84	9.91	8	AB
D	0.735	0.765	18.67	19.43	14	AC
D	0.745	0.765	18.92	19.43	16	AA
D	0.885	0.915	22.48	23.24	18	AD
D	1.015	1.045	25.78	26.54	20	AE
D	1.14	1.265	28.96	32.13	24	AF
D	1.360	1.380	34.54	35.05	28	*5

NOTES:

1. D&E DO NOT INCLUDE MOLD FLASH
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED .15mm (.006")
3. CONTROLLING DIMENSION: MILLIMETER
4. MEETS JEDEC MS001-XX AS SHOWN IN ABOVE TABLE
5. SIMILAR TO JEDEC MO-058AB
6. N = NUMBER OF PINS



PACKAGE FAMILY OUTLINE: PDIP .300" TITLE

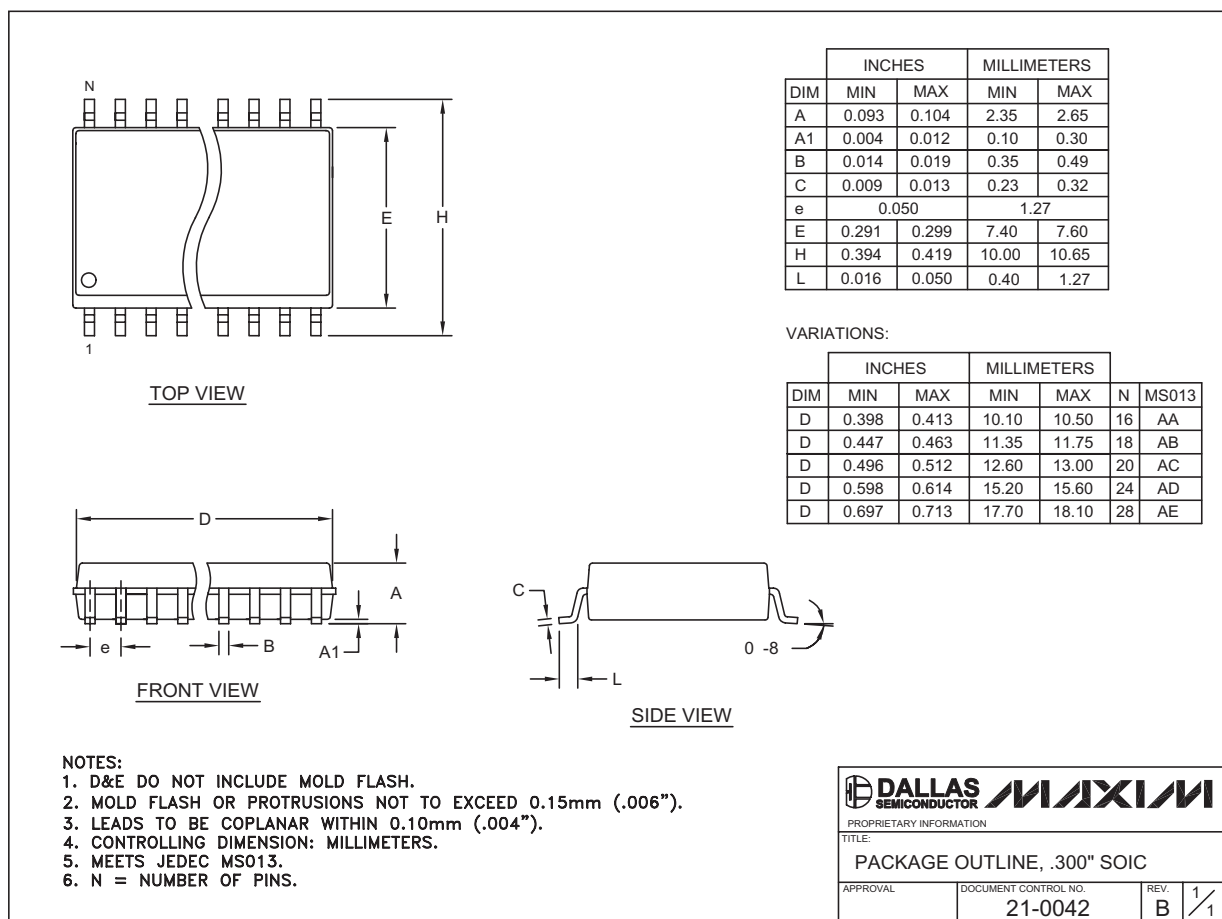
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21-0043 D DOCUMENT CONTROL NUMBER REV

TTL Compatible CMOS Analog Switches

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



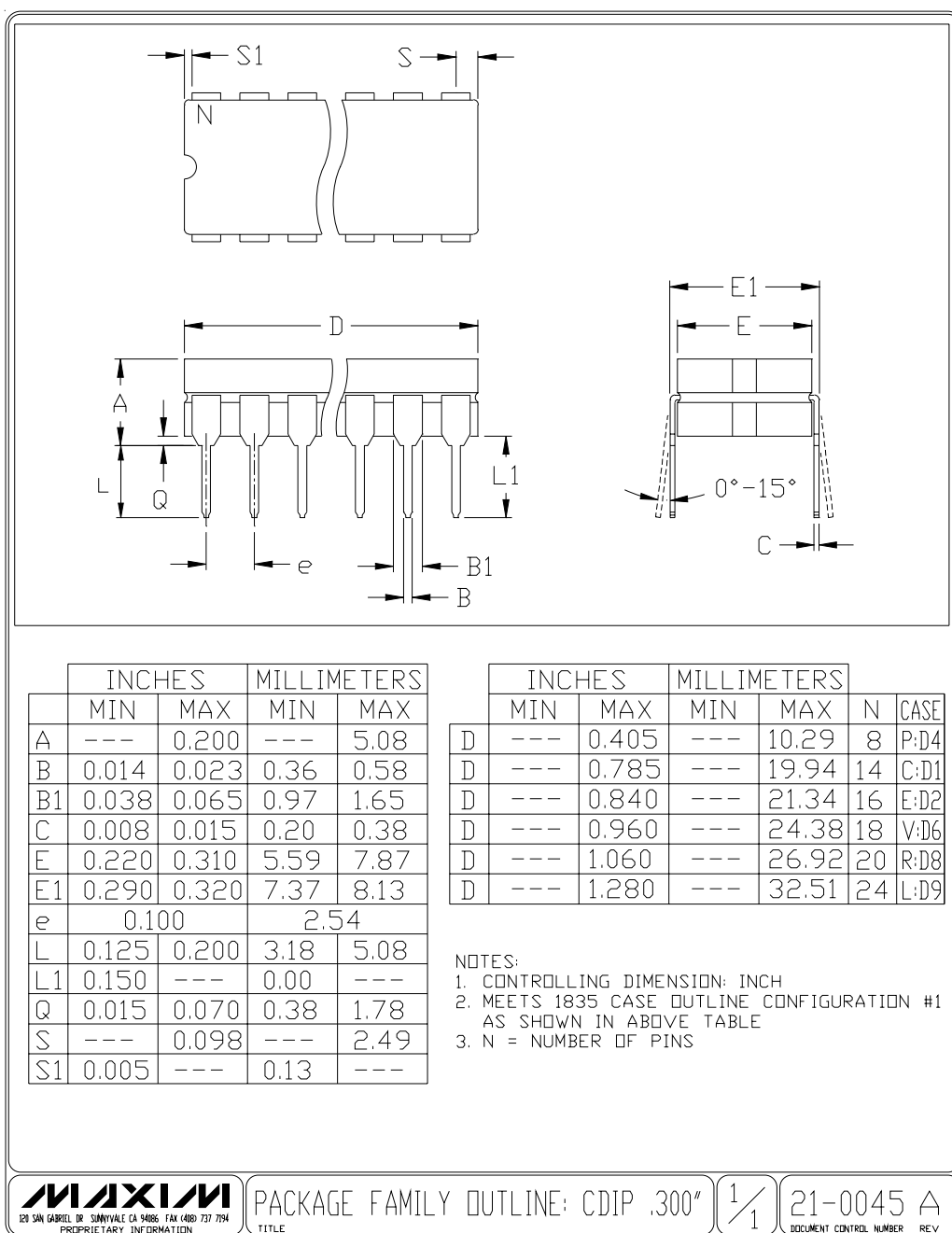
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DG300(A)/DG301(A)/DG302(A)/DG303(A)

TTL Compatible CMOS Analog Switches

Package Information (continued)

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